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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	7KB (4K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	192 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16lc63t-04-so">https://www.e-xfl.com/product-detail/microchip-technology/pic16lc63t-04-so</a>

## 4.2.2.1 STATUS REGISTER

### Applicable Devices

61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67
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The STATUS register, shown in Figure 4-9, contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the  $\overline{TO}$  and  $\overline{PD}$  bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear the upper-three bits and set the Z bit. This leaves the STATUS register as 000u u1uu (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register because these instructions do not affect the Z, C or DC bits from the STATUS register. For other instructions, not affecting any status bits, see the "Instruction Set Summary."

**Note 1:** For those devices that do not use bits IRP and RP1 (STATUS<7:6>), maintain these bits clear to ensure upward compatibility with future products.

**Note 2:** The C and DC bits operate as a borrow and digit borrow bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

**FIGURE 4-9: STATUS REGISTER (ADDRESS 03h, 83h, 103h, 183h)**

R/W-0	R/W-0	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x
IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C
bit7							bit0
<p>bit 7: <b>IRP:</b> Register Bank Select bit (used for indirect addressing)  1 = Bank 2, 3 (100h - 1FFh)  0 = Bank 0, 1 (00h - FFh)</p> <p>bit 6-5: <b>RP1:RP0:</b> Register Bank Select bits (used for direct addressing)  11 = Bank 3 (180h - 1FFh)  10 = Bank 2 (100h - 17Fh)  01 = Bank 1 (80h - 7Fh)  00 = Bank 0 (00h - 7Fh)  Each bank is 128 bytes.</p> <p>bit 4: <b><math>\overline{TO}</math>:</b> Time-out bit  1 = After power-up, CLRWDI instruction, or SLEEP instruction  0 = A WDT time-out occurred</p> <p>bit 3: <b><math>\overline{PD}</math>:</b> Power-down bit  1 = After power-up or by the CLRWDI instruction  0 = By execution of the SLEEP instruction</p> <p>bit 2: <b>Z:</b> Zero bit  1 = The result of an arithmetic or logic operation is zero  0 = The result of an arithmetic or logic operation is not zero</p> <p>bit 1: <b>DC:</b> Digit carry/borrow bit (for ADDWF, ADDLW, SUBLW, and SUBWF instructions) (For borrow the polarity is reversed).  1 = A carry-out from the 4th low order bit of the result occurred  0 = No carry-out from the 4th low order bit of the result</p> <p>bit 0: <b>C:</b> Carry/borrow bit (for ADDWF, ADDLW, SUBLW, and SUBWF instructions) (For borrow the polarity is reversed).  1 = A carry-out from the most significant bit of the result occurred  0 = No carry-out from the most significant bit of the result</p> <p>Note: a subtraction is executed by adding the two's complement of the second operand.  For rotate (RRF, RLF) instructions, this bit is loaded with either the high or low order bit of the source register.</p>							

R = Readable bit  
W = Writable bit  
- n = Value at POR reset  
x = unknown

# PIC16C6X

**TABLE 5-1: PORTA FUNCTIONS**

Name	Bit#	Buffer Type	Function
RA0	bit0	TTL	Input/output
RA1	bit1	TTL	Input/output
RA2	bit2	TTL	Input/output
RA3	bit3	TTL	Input/output
RA4/T0CKI	bit4	ST	Input/output or external clock input for Timer0. Output is open drain type.
RA5/ $\overline{SS}$ <sup>(1)</sup>	bit5	TTL	Input/output or slave select input for synchronous serial port.

Legend: TTL = TTL input, ST = Schmitt Trigger input

Note 1: The PIC16C61 does not have PORTA<5> or TRISA<5>, read as '0'.

**TABLE 5-2: REGISTERS/BITS ASSOCIATED WITH PORTA**

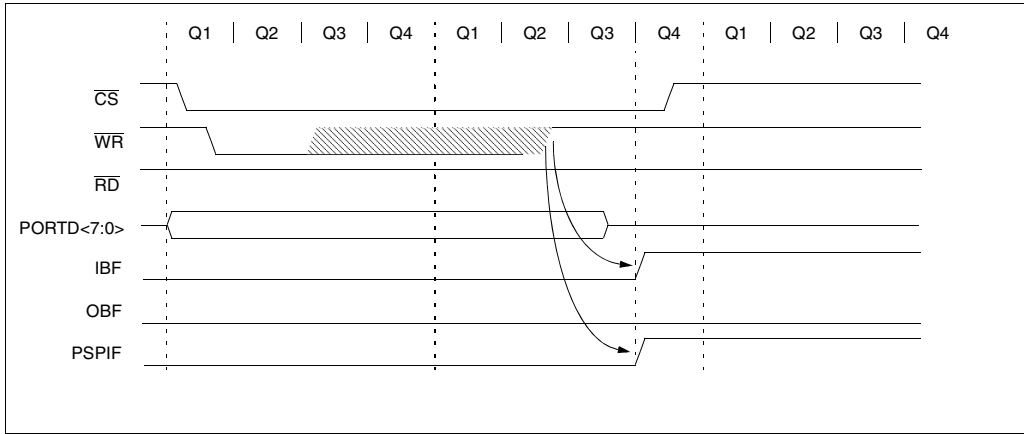
Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
05h	PORTA	—	—	RA5 <sup>(1)</sup>	RA4	RA3	RA2	RA1	RA0	--xx xxxx	--uu uuuu
85h	TRISA	—	—	PORTA Data Direction Register <sup>(1)</sup>						--11 1111	--11 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA.

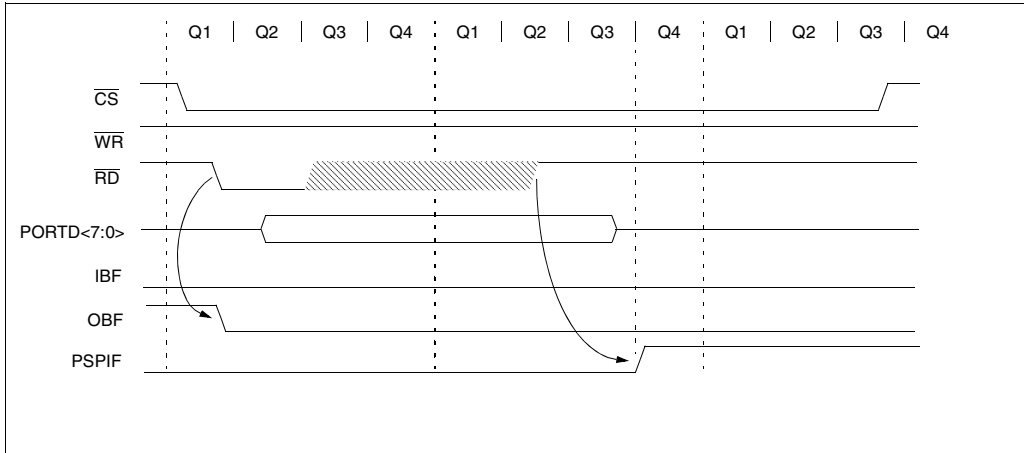
Note 1: PORTA<5> and TRISA<5> are not implemented on the PIC16C61, read as '0'.

# PIC16C6X

**FIGURE 5-12: PARALLEL SLAVE PORT WRITE WAVEFORMS**



**FIGURE 5-13: PARALLEL SLAVE PORT READ WAVEFORMS**



**TABLE 5-13: REGISTERS ASSOCIATED WITH PARALLEL SLAVE PORT**

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
08h	PORTD	PSP7	PSP6	PSP5	PSP4	PSP3	PSP2	PSP1	PSP0	xxxx xxxx	uuuu uuuu
09h	PORTE	—	—	—	—	—	RE2	RE1	RE0	---- -xxx	---- -uuu
89h	TRISE	IBF	OBF	IBOV	PSPMODE	—	PORTE Data Direction Bits			0000 -111	0000 -111
0Ch	PIR1	PSPIF	(1)	RCIF(2)	TXIF(2)	SSPIF	CCP1IF	TMR2IF	TRM1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE	(1)	RCIE(2)	TXIE(2)	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by the PSP.

Note 1: These bits are reserved, always maintain these bits clear.

2: These bits are implemented on the PIC16C65/65A/R65/67 only.

# PIC16C6X

## 8.5 Resetting Timer1 using a CCP Trigger Output

Applicable Devices													
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67

CCP2 is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.

If CCP1 or CCP2 module is configured in Compare mode to generate a "special event trigger" (CCPxM3:CCPxM0 = 1011), this signal will reset Timer1.

**Note:** The "special event trigger" from the CCP1 and CCP2 modules will not set interrupt flag bit TMR1IF (PIR1<0>).

Timer1 must be configured for either timer or synchronized counter mode to take advantage of this feature. If the Timer1 is running in asynchronous counter mode, this reset operation may not work.

In the event that a write to Timer1 coincides with a special event trigger from CCP1 or CCP2, the write will take precedence.

In this mode of operation, the CCPRxH:CCPRxL registers pair effectively becomes the period register for the Timer1 module.

## 8.6 Resetting of TMR1 Register Pair (TMR1H:TMR1L)

Applicable Devices													
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67

The TMR1H and TMR1L registers are not reset to 00h on a POR or any other reset except by the CCP1 or CCP2 special event trigger.

The T1CON register is reset to 00h on a Power-on Reset or a Brown-out Reset, which shuts off the timer and leaves a 1:1 prescaler. In all other resets, the register is unaffected.

## 8.7 Timer1 Prescaler

Applicable Devices													
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67

The prescaler counter is cleared on writes to the TMR1H or TMR1L registers.

**TABLE 8-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER**

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF <sup>(2)</sup>	<sup>(3)</sup>	RCIF <sup>(1)</sup>	TXIF <sup>(1)</sup>	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE <sup>(2)</sup>	<sup>(3)</sup>	RCIE <sup>(1)</sup>	TXIE <sup>(1)</sup>	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
0Eh	TMR1L	Holding register for the Least Significant Byte of the 16-bit TMR1 register								xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding register for the Most Significant Byte of the 16-bit TMR1 register								xxxx xxxx	uuuu uuuu
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR1ON	--00 0000	--uu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by the Timer1 module.

Note 1: The USART is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.

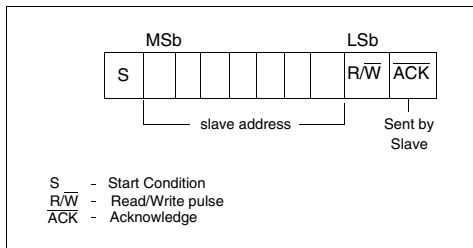
2: Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.

3: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

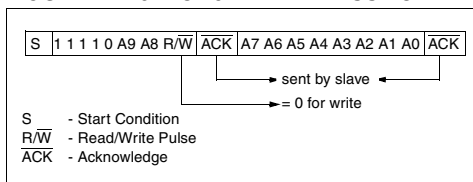
## 11.4.2 ADDRESSING I<sup>2</sup>C DEVICES

There are two address formats. The simplest is the 7-bit address format with a R/W bit (Figure 11-15). The more complex is the 10-bit address with a R/W bit (Figure 11-16). For 10-bit address format, two bytes must be transmitted with the first five bits specifying this to be a 10-bit address.

**FIGURE 11-15: 7-BIT ADDRESS FORMAT**



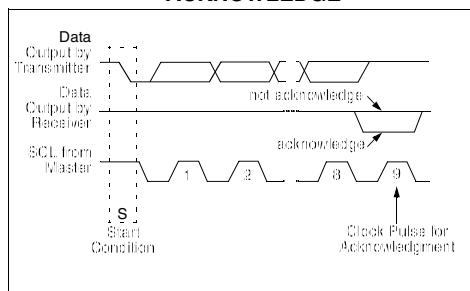
**FIGURE 11-16: I<sup>2</sup>C 10-BIT ADDRESS FORMAT**



## 11.4.3 TRANSFER ACKNOWLEDGE

All data must be transmitted per byte, with no limit to the number of bytes transmitted per data transfer. After each byte, the slave-receiver generates an acknowledge bit (ACK) (Figure 11-17). When a slave-receiver doesn't acknowledge the slave address or received data, the master must abort the transfer. The slave must leave SDA high so that the master can generate the STOP condition (Figure 11-14).

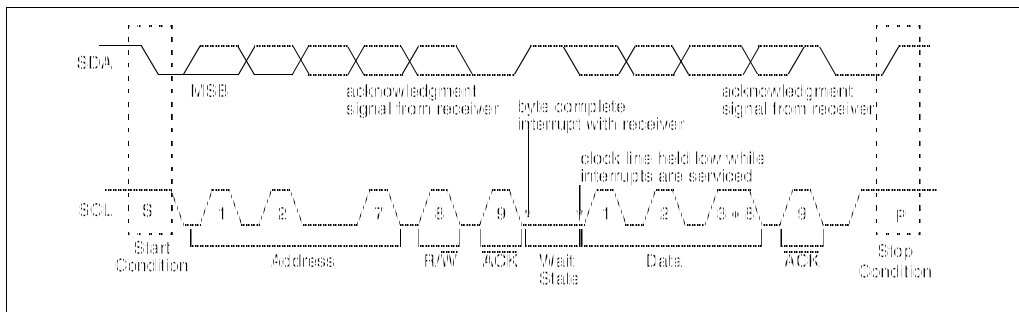
**FIGURE 11-17: SLAVE-RECEIVER ACKNOWLEDGE**



If the master is receiving the data (master-receiver), it generates an acknowledge signal for each received byte of data, except for the last byte. To signal the end of data to the slave-transmitter, the master does not generate an acknowledge (not acknowledge). The slave then releases the SDA line so the master can generate the STOP condition. The master can also generate the STOP condition during the acknowledge pulse for valid termination of data transfer.

If the slave needs to delay the transmission of the next byte, holding the SCL line low will force the master into a wait state. Data transfer continues when the slave releases the SCL line. This allows the slave to move the received data or fetch the data it needs to transfer before allowing the clock to start. This wait state technique can also be implemented at the bit level, Figure 11-18. The slave will inherently stretch the clock, when it is a transmitter, but will not when it is a receiver. The slave will have to clear the SSPCON<4> bit to enable clock stretching when it is a receiver.

**FIGURE 11-18: DATA TRANSFER WAIT STATE**



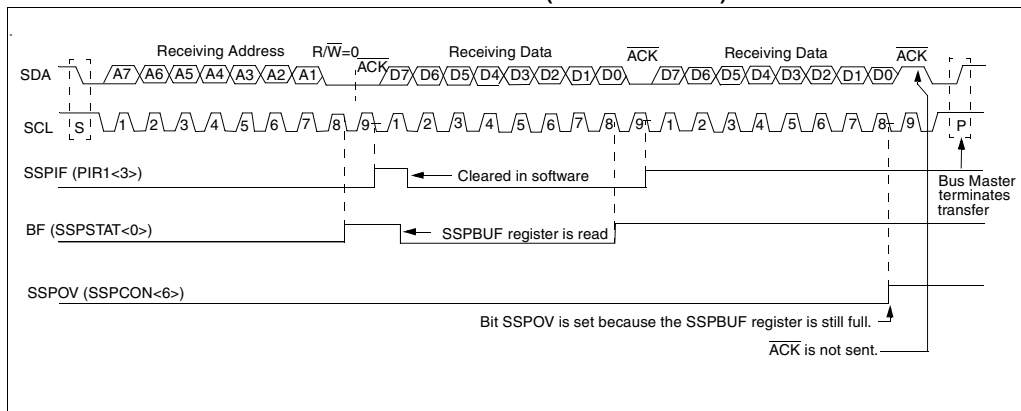
## 11.5.1.2 RECEPTION

When the  $\overline{R/\overline{W}}$  bit of the address byte is clear and an address match occurs, the  $\overline{R/\overline{W}}$  bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register.

When the address byte overflow condition exists, then no acknowledge ( $\overline{ACK}$ ) pulse is given. An overflow condition is defined as either bit BF (SSPSTAT<0>) is set or bit SSPOV (SSPCON<6>) is set.

An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF (PIR1<3>) must be cleared in software. The SSPSTAT register is used to determine the status of the byte.

**FIGURE 11-25: I<sup>2</sup>C WAVEFORMS FOR RECEPTION (7-BIT ADDRESS)**



## 14.1 Instruction Descriptions

### ADDLW Add Literal and W

Syntax:	[ <i>label</i> ] ADDLW k			
Operands:	$0 \leq k \leq 255$			
Operation:	$(W) + k \rightarrow (W)$			
Status Affected:	C, DC, Z			
Encoding:	11	111x	kkkk	kkkk
Description:	The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read literal 'k'	Process data	Write to W

Example:

```

ADDLW    0x15
Before Instruction
W    =    0x10
After Instruction
W    =    0x25
  
```

### ADDWF Add W and f

Syntax:	[ <i>label</i> ] ADDWF f,d			
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$			
Operation:	$(W) + (f) \rightarrow (\text{destination})$			
Status Affected:	C, DC, Z			
Encoding:	00	0111	dfff	ffff
Description:	Add the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination

Example

```

ADDWF    FSR, 0
Before Instruction
W    =    0x17
FSR =    0xC2
After Instruction
W    =    0xD9
FSR =    0xC2
  
```

### ANDLW AND Literal with W

Syntax:	[ <i>label</i> ] ANDLW k			
Operands:	$0 \leq k \leq 255$			
Operation:	$(W) .\text{AND.} (k) \rightarrow (W)$			
Status Affected:	Z			
Encoding:	11	1001	kkkk	kkkk
Description:	The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read literal "k"	Process data	Write to W

Example

```

ANDLW    0x5F
Before Instruction
W    =    0xA3
After Instruction
W    =    0x03
  
```

### ANDWF AND W with f

Syntax:	[ <i>label</i> ] ANDWF f,d			
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$			
Operation:	$(W) .\text{AND.} (f) \rightarrow (\text{destination})$			
Status Affected:	Z			
Encoding:	00	0101	dfff	ffff
Description:	AND the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination

Example

```

ANDWF    FSR, 1
Before Instruction
W    =    0x17
FSR =    0xC2
After Instruction
W    =    0x17
FSR =    0x02
  
```



## SUBWF Subtract W from f

Syntax: [ *label* ] SUBWF f,d

Operands:  $0 \leq f \leq 127$   
 $d \in [0,1]$

Operation:  $(f) - (W) \rightarrow (\text{destination})$

Status Affected: C, DC, Z

Encoding: 

00	0010	dfff	ffff
----	------	------	------

Description: Subtract (2's complement method) W register from register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity: 

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process data	Write to destination

Example 1: SUBWF REG1, 1

Before Instruction

REG1 = 3  
W = 2  
C = ?  
Z = ?

After Instruction

REG1 = 1  
W = 2  
C = 1; result is positive  
Z = 0

Example 2: Before Instruction

REG1 = 2  
W = 2  
C = ?  
Z = ?

After Instruction

REG1 = 0  
W = 2  
C = 1; result is zero  
Z = 1

Example 3: Before Instruction

REG1 = 1  
W = 2  
C = ?  
Z = ?

After Instruction

REG1 = 0xFF  
W = 2  
C = 0; result is negative  
Z = 0

## SWAPF Swap Nibbles in f

Syntax: [ *label* ] SWAPF f,d

Operands:  $0 \leq f \leq 127$   
 $d \in [0,1]$

Operation:  $(f<3:0>) \rightarrow (\text{destination}<7:4>)$ ,  
 $(f<7:4>) \rightarrow (\text{destination}<3:0>)$

Status Affected: None

Encoding: 

00	1110	dfff	ffff
----	------	------	------

Description: The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity: 

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process data	Write to destination

Example SWAPF REG, 0

Before Instruction

REG1 = 0xA5

After Instruction

REG1 = 0xA5  
W = 0x5A

## TRIS Load TRIS Register

Syntax: [ *label* ] TRIS f

Operands:  $5 \leq f \leq 7$

Operation:  $(W) \rightarrow \text{TRIS register } f$ ;

Status Affected: None

Encoding: 

00	0000	0110	0fff
----	------	------	------

Description: The instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them.

Words: 1

Cycles: 1

Example

**To maintain upward compatibility with future PIC16CXX products, do not use this instruction.**

# PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

## 15.3 DC Characteristics: PIC16C61-04 (Commercial, Industrial, Extended) PIC16C61-20 (Commercial, Industrial, Extended) PIC16LC61-04 (Commercial, Industrial)

<b>Standard Operating Conditions (unless otherwise stated)</b> Operating temperature    -40°C ≤ TA ≤ +125°C for extended, -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial Operating voltage VDD range as described in DC spec Section 15.1 and Section 15.2.							
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
<b>DC CHARACTERISTICS</b>							
<b>Input Low Voltage</b>							
D030	I/O ports	VIL					
D030A	with TTL buffer		VSS	-	0.15VDD	V	For entire VDD range
D031	with Schmitt Trigger buffer		VSS	-	0.8V	V	4.5V ≤ VDD ≤ 5.5V
D032	MCLR, OSC1 (in RC mode)		VSS	-	0.2VDD	V	
D033	OSC1 (in XT, HS and LP)		VSS	-	0.2VDD	V	Note1
<b>Input High Voltage</b>							
D040	I/O ports	VIH		-			
D040A	with TTL buffer		2.0	-	VDD	V	4.5V ≤ VDD ≤ 5.5V
			0.25VDD + 0.8V	-	VDD	V	For entire VDD range
D041	with Schmitt Trigger buffer		0.85VDD	-	VDD	V	For entire VDD range
D042	MCLR		0.85VDD	-	VDD	V	
D042A	OSC1 (XT, HS and LP)		0.7VDD	-	VDD	V	Note1
D043	OSC1 (in RC mode)		0.9VDD	-	VDD	V	
D070	PORTB weak pull-up current	IPURB	50	250	† 400	μA	VDD = 5V, VPIN = VSS
<b>Input Leakage Current (Notes 2, 3)</b>							
D060	I/O ports	IIL	-	-	±1	μA	VSS ≤ VPIN ≤ VDD, Pin at hi-impedance
D061	MCLR, RA4/T0CKI		-	-	±5	μA	VSS ≤ VPIN ≤ VDD
D063	OSC1		-	-	±5	μA	VSS ≤ VPIN ≤ VDD, XT, HS and LP osc configuration
<b>Output Low Voltage</b>							
D080	I/O ports	VOL	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C
D080A			-	-	0.6	V	IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C
D083A			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C

\* The parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

# PIC16C6X

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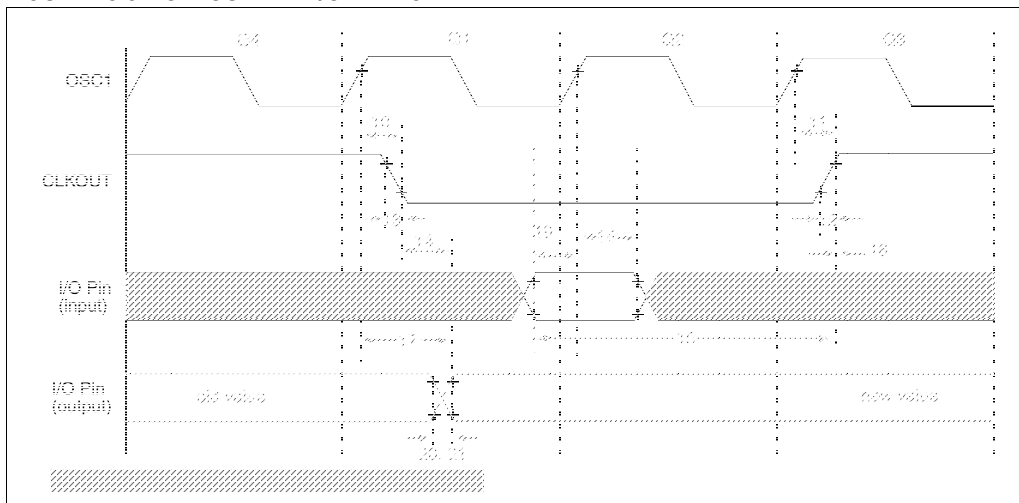
Applicable Devices	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67
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NOTES:

# PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

**FIGURE 18-3: CLKOUT AND I/O TIMING**



**TABLE 18-3: CLKOUT AND I/O TIMING REQUIREMENTS**

Parameters	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓	—	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑	—	75	200	ns	Note 1
12*	TckR	CLKOUT rise time	—	35	100	ns	Note 1
13*	TckF	CLKOUT fall time	—	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid	—	—	0.5T <sub>CY</sub> + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑	T <sub>osc</sub> + 200	—	—	ns	Note 1
16*	TckH2ioL	Port in hold after CLKOUT ↑	0	—	—	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid	—	50	150	ns	
18*	TosH2ioL	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	PIC16C62A/ R62/64A/R64	100	—	—	ns
			PIC16LC62A/ R62/64A/R64	200	—	—	ns
19*	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	0	—	—	ns	
20*	TioR	Port output rise time	PIC16C62A/ R62/64A/R64	—	10	40	ns
			PIC16LC62A/ R62/64A/R64	—	—	80	ns
21*	TioF	Port output fall time	PIC16C62A/ R62/64A/R64	—	10	40	ns
			PIC16LC62A/ R62/64A/R64	—	—	80	ns
22††	Tinp	RB0/INT pin high or low time	T <sub>CY</sub>	—	—	ns	
23††	Trbp	RB7:RB4 change int high or low time	T <sub>CY</sub>	—	—	ns	

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

†† These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x T<sub>OSC</sub>.

## 20.0 ELECTRICAL CHARACTERISTICS FOR PIC16C63/65A

### Absolute Maximum Ratings (†)

Ambient temperature under bias.....	-55°C to +125°C
Storage temperature .....	-65°C to +150°C
Voltage on any pin with respect to VSS (except VDD, MCLR, and RA4).....	-0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS .....	-0.3V to +7.5V
Voltage on MCLR with respect to VSS (Note 2).....	0V to +14V
Voltage on RA4 with respect to VSS.....	0V to +14V
Total power dissipation (Note 1).....	1.0W
Maximum current out of VSS pin .....	300 mA
Maximum current into VDD pin .....	250 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > VDD).....	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > VDD) .....	±20 mA
Maximum output current sunk by any I/O pin.....	25 mA
Maximum output current sourced by any I/O pin .....	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (Note 3) (combined).....	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (Note 3) (combined) .....	200 mA
Maximum current sunk by PORTC and PORTD (Note 3) (combined) .....	200 mA
Maximum current sourced by PORTC and PORTD (Note 3) (combined) .....	200 mA

**Note 1:** Power dissipation is calculated as follows:  $P_{dis} = VDD \times \{I_{DD} - \sum I_{OH}\} + \sum \{(VDD - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$

**Note 2:** Voltage spikes below VSS at the MCLR/VPP pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a “low” level to the MCLR/VPP pin rather than pulling this pin directly to VSS.

**Note 3:** PORTD and PORTE not available on the PIC16C63.

† NOTICE: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**TABLE 20-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)**

OSC	PIC16C63-04 PIC16C65A-04	PIC16C63-10 PIC16C65A-10	PIC16C63-20 PIC16C65A-20	PIC16LC63-04 PIC16LC65A-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 10 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 10 MHz max.	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 µA typ. at 32 kHz, 4.0V IPD: 0.9 µA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 2.5V to 6.0V IDD: 48 µA max. at 32 kHz, 3.0V IPD: 5 µA max. at 3.0V Freq: 200 kHz max.	VDD: 2.5V to 6.0V IDD: 48 µA max. at 32 kHz, 3.0V IPD: 5 µA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

# PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

## 20.1 DC Characteristics: PIC16C63/65A-04 (Commercial, Industrial, Extended) PIC16C63/65A-10 (Commercial, Industrial, Extended) PIC16C63/65A-20 (Commercial, Industrial, Extended)

Standard Operating Conditions (unless otherwise stated)						
Operating temperature -40°C ≤ TA ≤ +125°C for extended, -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial						
Param No.	Characteristic	Sym	Min	Typ†	Max	Units
D001 D001A	Supply Voltage	VDD	4.0 4.5	- -	6.0 5.5	V V
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	VSS	-	V
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms
D005	Brown-out Reset Voltage	BVDD	3.7 3.7	4.0 4.0	4.3 4.4	V V
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA
D013			-	10	20	mA
D015*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μA
D020 D021 D021A D021B	Power-down Current (Note 3, 5)	IPD	- - - -	10.5 1.5 1.5 2.5	42 16 19 19	μA μA μA μA
D023*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μA

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

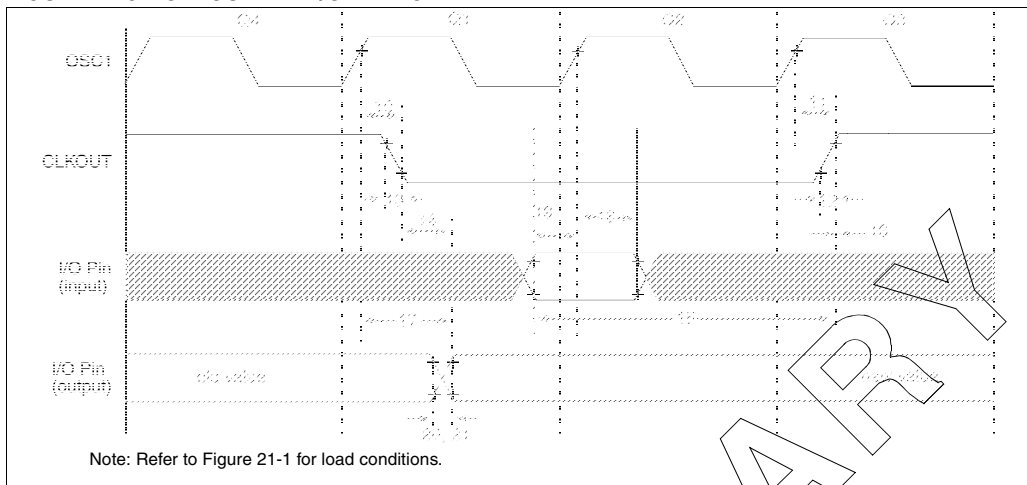
MCLR = VDD; WDT enabled/disabled as specified.

3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula  $I_r = V_{DD}/2R_{ext}$  (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.



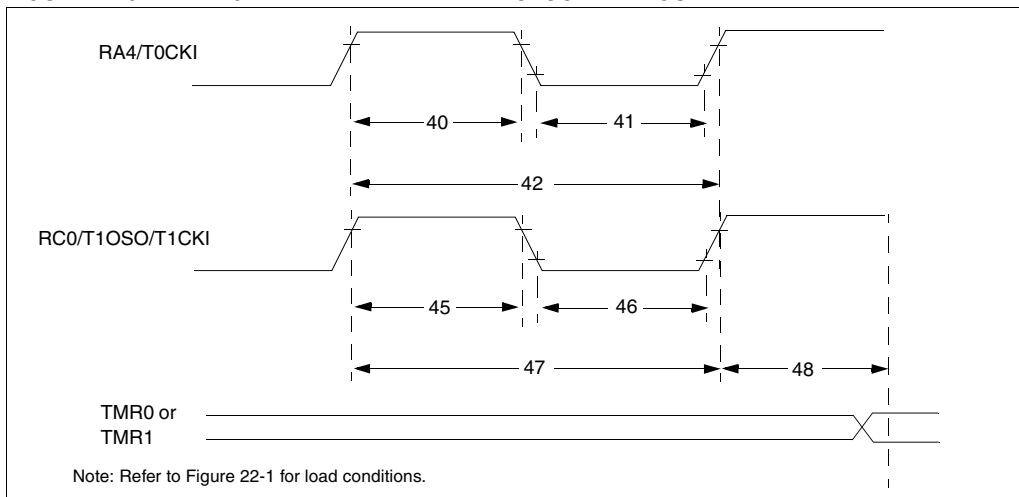
Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓	—	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑	—	75	200	ns	Note 1
12*	TckR	CLKOUT rise time	—	35	100	ns	Note 1
13*	TckF	CLKOUT fall time	—	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid	—	—	0.5T <sub>CY</sub> + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑	Tosc + 200	—	—	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT ↑	0	—	—	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid	—	50	150	ns	
18*	TosH2iol	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	PIC16C63/R65	100	—	—	ns
			PIC16LC63/R65	200	—	—	ns
19*	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	0	—	—	ns	
20*	TioR	Port output rise time	PIC16C63/R65	—	10	40	ns
			PIC16LC63/R65	—	—	80	ns
21*	TioF	Port output fall time	PIC16C63/R65	—	10	40	ns
			PIC16LC63/R65	—	—	80	ns
22††*	Tinp	INT pin high or low time	T <sub>CY</sub>	—	—	ns	
23††*	TRbp	RB7-RB4 change INT high or low time	T <sub>CY</sub>	—	—	ns	

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x TOSC.

# PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

**FIGURE 22-6: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS**



**TABLE 22-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS**

Param No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width	No Prescaler	$0.5T_{CY} + 20$	—	—	ns	Must also meet parameter 42
			With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width	No Prescaler	$0.5T_{CY} + 20$	—	—	ns	Must also meet parameter 42
			With Prescaler	10	—	—	ns	
42*	Tt0P	T0CKI Period	No Prescaler	$T_{CY} + 40$	—	—	ns	
			With Prescaler	Greater of: $20$ or $T_{CY} + 40$ N	—	—	ns	N = prescale value (2, 4, ..., 256)
45*	Tt1H	T1CKI High Time	Synchronous, Prescaler = 1	$0.5T_{CY} + 20$	—	—	ns	Must also meet parameter 47
		Synchronous, Prescaler = 2,4,8	PIC16C6X	15	—	—	ns	
			PIC16LC6X	25	—	—	ns	
		Asynchronous	PIC16C6X	30	—	—	ns	
			PIC16LC6X	50	—	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, Prescaler = 1	$0.5T_{CY} + 20$	—	—	ns	Must also meet parameter 47
		Synchronous, Prescaler = 2,4,8	PIC16C6X	15	—	—	ns	
			PIC16LC6X	25	—	—	ns	
		Asynchronous	PIC16C6X	30	—	—	ns	
			PIC16LC6X	50	—	—	ns	
47*	Tt1P	T1CKI input period	Synchronous	Greater of: $30$ OR $T_{CY} + 40$ N	—	—	ns	N = prescale value (1, 2, 4, 8)
			PIC16LC6X	Greater of: $50$ OR $T_{CY} + 40$ N				N = prescale value (1, 2, 4, 8)
		Asynchronous	PIC16C6X	60	—	—	ns	
			PIC16LC6X	100	—	—	ns	
	Ft1	Timer1 oscillator input frequency range (oscillator enabled by setting bit T1OSCEN)		DC	—	200	kHz	
48	TCKEZtmr1	Delay from external clock edge to timer increment		$2T_{osc}$	—	$7T_{osc}$	—	

\* These parameters are characterized but not tested.

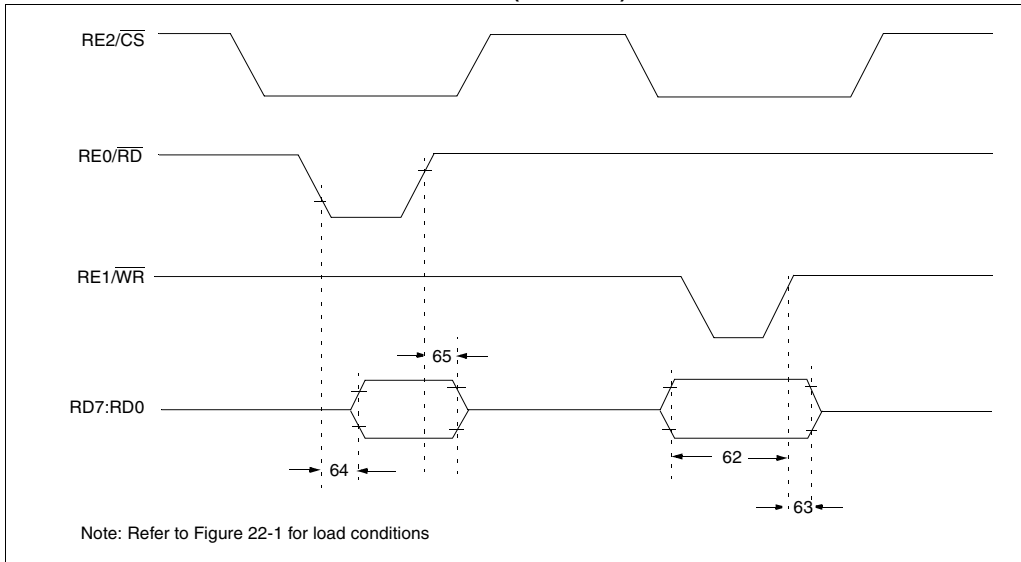
† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.



# PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

**FIGURE 22-8: PARALLEL SLAVE PORT TIMING (PIC16C67)**



**TABLE 22-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C67)**

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
62*	TdtV2wrH	Data in valid before $\overline{WR}\uparrow$ or $\overline{CS}\uparrow$ (setup time)	20	—	—	ns	Extended Range Only
			25	—	—	ns	
63*	TwrH2dtI	$\overline{WR}\uparrow$ or $\overline{CS}\uparrow$ to data-in invalid (hold time)	PIC16C67 20	—	—	ns	
			PIC16LC67 35	—	—	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data-out valid	—	—	80	ns	Extended Range Only
			—	—	90	ns	
65*	TrdH2dtI	$\overline{RD}\uparrow$ or $\overline{CS}\uparrow$ to data-out invalid	10	—	30	ns	

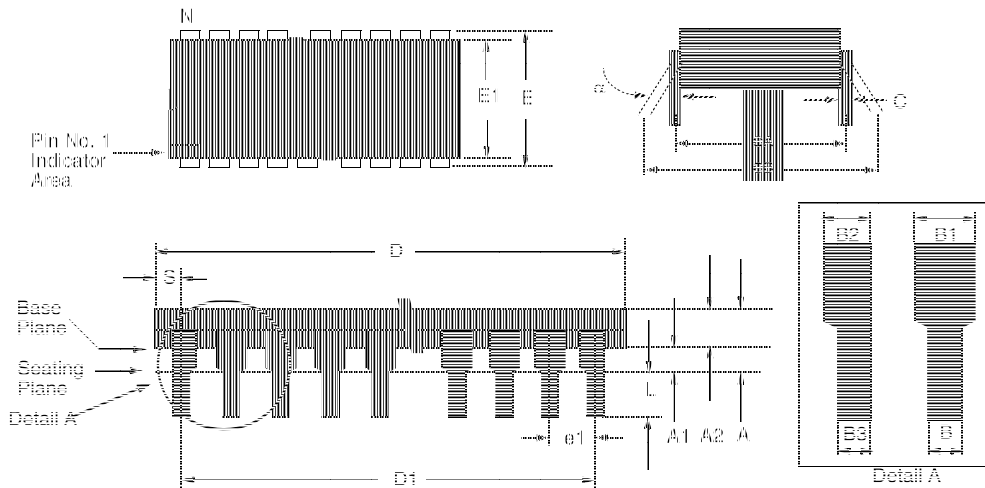
\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

# PIC16C6X

## 24.2 28-Lead Plastic Dual In-line (300 mil) (SP)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Package Group: Plastic Dual In-Line (PLA)						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
$\alpha$	0°	10°		0°	10°	
A	3.632	4.572		0.143	0.180	
A1	0.381	—		0.015	—	
A2	3.175	3.556		0.125	0.140	
B	0.406	0.559		0.016	0.022	
B1	1.016	1.651	Typical	0.040	0.065	Typical
B2	0.762	1.016	4 places	0.030	0.040	4 places
B3	0.203	0.508	4 places	0.008	0.020	4 places
C	0.203	0.331	Typical	0.008	0.013	Typical
D	34.163	35.179		1.385	1.395	
D1	33.020	33.020	Reference	1.300	1.300	Reference
E	7.874	8.382		0.310	0.330	
E1	7.112	7.493		0.280	0.295	
e1	2.540	2.540	Typical	0.100	0.100	Typical
eA	7.874	7.874	Reference	0.310	0.310	Reference
eB	8.128	9.652		0.320	0.380	
L	3.175	3.683		0.125	0.145	
N	28	28		28	28	
S	0.584	1.220		0.023	0.048	

## APPENDIX C: WHAT'S NEW

Added PIC16CR63 and PIC16CR65 devices.

Added PIC16C66 and PIC16C67 devices. The PIC16C66/67 devices have 368 bytes of data memory distributed in 4 banks and 8K of program memory in 4 pages. These two devices have an enhanced SPI that supports both clock phase and polarity. The USART has been enhanced.

When upgrading to the PIC16C66/67 please note that the upper 16 bytes of data memory in banks 1,2, and 3 are mapped into bank 0. This may require relocation of data memory usage in the user application code.

Q-cycles for instruction execution were added to Section 14.0 Instruction Set Summary.

## APPENDIX D: WHAT'S CHANGED

Minor changes, spelling and grammatical changes.

Divided SPI section into SPI for the PIC16C66/67 (Section 11.3) and SPI for all other devices (Section 11.2).

Added the following note for the USART. This applies to all devices except the PIC16C66 and PIC16C67.

For the PIC16C63/R63/65/65A/R65 the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information or use the PIC16C66/67.

## APPENDIX E: REVISION E

January 2013 - Added a note to each package drawing.

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